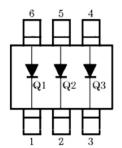
Schottky Barrier Diode

multicomp PRO



Features:

- · Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- · Fast Switching
- Low Leakage Current
- · Three Fully Isolated Schottky Diode
- · Also Available in Lead Free Version





Applications:

High speed switching

SOT-363

Maximum Rating @ TA = 25°C unless otherwise specified

Parameter	Symbol	SD103ATW-7-F	Unit
Peak repetitive reverse voltage Working peak reverse voltage DC blocking voltage	V _{RRM} V _{RWM} V _R	40	V
RMS reverse voltage	V _{R(RMS)}	28	V
Forward continuous current (Max.)	I _F	350	mA
Average rectified current	Io	175	mA
Non-Repetitive peak forward surge current @t ≤ 10ms	I _{FSM}	1	А
Thermal resistance, junction to ambient air	$R_{\theta JA}$	500	°C/W
Power dissipation	P_{D}	200	mW
Junction and storage temperature	T _{j,} T _{stg}	-55 to +125	°C

Electrical Characteristics @ TA = 25°C unless otherwise specified

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Reverse breakdown voltage	V _{(BR)R}	I _R = 100μA	40		-	V
Average reverse current	I _R	V _R = 10V V _R = 30V		0.2 0.4	2 5	μΑ

Newark.com/multicomp-pro Farnell.com/multicomp-pro Element14.com/multicomp-pro

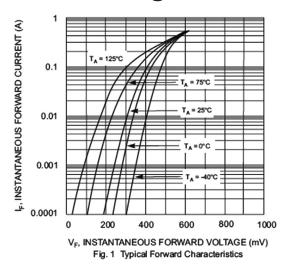


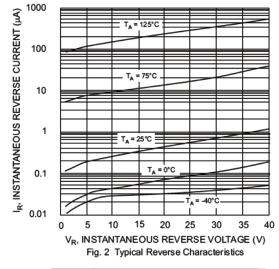
Schottky Barrier Diode multicomp PRO



Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	V _F	$I_F = 1mA$ $I_F = 5mA$ $I_F = 20mA$ $I_F = 100mA$	-	0.27 0.32 0.36 0.44	0.37 0.5	V
Total capacitance	C _T	V _R = 0V, f = 1MHz	-	50	-	pF
Reverse recovery time	t _{rr}	$I_F = I_R = 200 \text{mA}, I_{rr} = 0.1 \text{*IR}$ $R_L = 100 \Omega$	-	10	-	ns

Typical Characteristics @ TA = 25°C unless otherwise specified





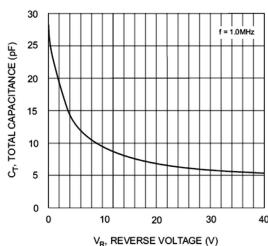
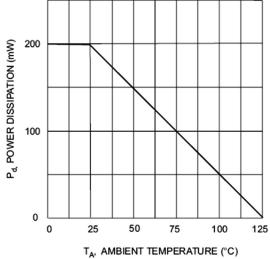


Fig. 3 Typ. Total Capacitance vs. Reverse Voltage



Newark.com/multicomp-pro Farnell.com/multicomp-pro Element14.com/multicomp-pro

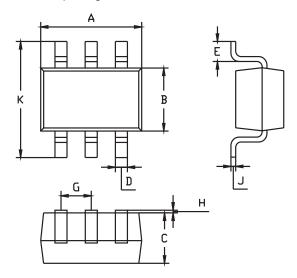
Fig. 4 Power Derating Curve

Schottky Barrier Diode multicomp PRO



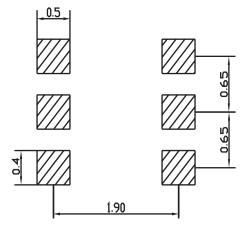
Package Outline

Plastic surface mounted package



SOT-363				
Dim	Min	Max		
Α	1.8	2.2		
В	1.15	1.35		
С	1 Typical			
D	0.10	0.30		
Е	0.25	0.40		
G	0.65 Typical			
Н	0.02	0.10		
J 0	.1Typical			
K	2.1	2.3		
All Dimensions in mm				

Soldering Footprint



Dimensions: Millimetres

Package Information

Device	Package	Shipping
SD103ATW-7-F	SOT-363	3,000/Tape & Reel

Part Number Table

Description	Part Number		
Schottky Barrier Diode	SD103ATW-7-F		

Important Notice: This data sheet and its contents (the "Information") belong to the members of the AVNET group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp Pro is the registered trademark of Premier Farnell Limited 2019.

Newark.com/multicomp-pro Farnell.com/multicomp-pro Element14.com/multicomp-pro

